

October 2013

FQB4N80 / FQI4N80

N-Channel QFET® MOSFET

800 V, 3.9 A, 3.6 Ω

Description

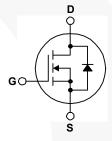
This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 3.9 A, 800 V, R_{DS(on)} = 3.6 Ω (Max.) @V_{GS} = 10 V, I_D = 1.95 A
- Low Gate Charge (Typ. 19 nC)
- Low Crss (Typ. 8.6 pF)
- · 100% Avalanche Tested







Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

	O °			
Symbol	Parameter		FQB4N80TM / FQI4N80TU	Unit
V_{DSS}	Drain-Source Voltage		800	V
I _D	Drain Current - Continuous (T _C = 25°	C)	3.9	Α
	- Continuous (T _C = 100)°C)	2.47	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	15.6	Α
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	460	mJ
I _{AR}	Avalanche Current	(Note 1)	3.9	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	13	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.0	V/ns
P_{D}	Power Dissipation (T _A = 25°C) *		3.13	W
	Power Dissipation (T _C = 25°C) - Derate above 25°C		130	W
			1.04	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	FQB4N80TM FQI4N80TU	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.96	
В	Thermal Resistance, Junction to Ambient (minimum pad of 2 oz copper), Max.	62.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (*1 in² pad of 2 oz copper), Max.	40	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQB4N80TM	FQB4N80	D ² -PAK	Tape and Reel	330 mm	24 mm	800 units
FQI4N80TU	FQI4N80	I ² -PAK	Tube	N/A	N/A	50 units

Electrical Characteristics T_C = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	800			V
ΔBV_{DSS} / ΔT_{J}	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.95		V/°C
I _{DSS}	Zana Cata Valtana Duain Courset	V _{DS} = 800 V, V _{GS} = 0 V		-	10	μА
	Zero Gate Voltage Drain Current	e Drain Current $V_{DS} = 640 \text{ V}, T_C = 125^{\circ}\text{C}$		-	100	μА
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V		-	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V		ì	-100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 1.95 A		2.8	3.6	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 50 V, I _D = 1.95 A		3.8		S
Dynam	ic Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$		680	880	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		75	100	pF
C _{rss}	Reverse Transfer Capacitance			8.6	12	pF
Switch	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V = 400 V I = 2.0 A		16	40	ns
t _r	Turn-On Rise Time	$V_{DD} = 400 \text{ V}, I_D = 3.9 \text{ A},$		45	100	ns
t _{d(off)}	Turn-Off Delay Time	$R_G = 25 \Omega$		35	80	ns
t _f	Turn-Off Fall Time	(Note 4)		35	80	ns
Qg	Total Gate Charge	V _{DS} = 640 V, I _D = 3.9 A,		19	25	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V	/	4.2		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		9.1		nC
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	Source Diode Characteristics an				0.0	
l _S	Maximum Continuous Drain-Source Diode Forward Current				3.9	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current			-	15.6	A
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 3.9 \text{ A}$			1.4	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V, } I_{S} = 3.9 \text{ A,}$ $dI_{F} / dt = 100 \text{ A/}\mu\text{s}$		575	//	ns
Q _{rr}	Reverse Recovery Charge	u _F / ut = 100 Α/μS		3.65		μС

- **Notes:** 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 57 mH, l_{AS} = 3.9 A, V_{DD} = 50 V, R_G = 25 Ω , Starting T_J = 25°C 3. $l_{SD} \le 3.9$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, Starting T_J = 25°C 4. Essentially independent of operating temperature

Typical Characteristics

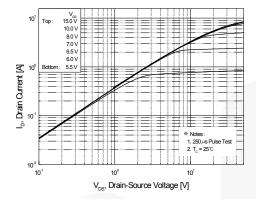


Figure 1. On-Region Characteristics

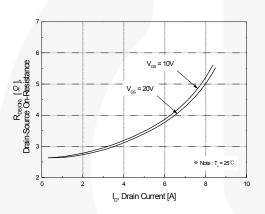


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

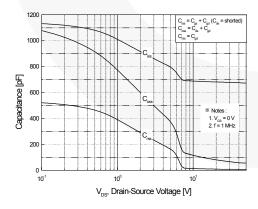


Figure 5. Capacitance Characteristics

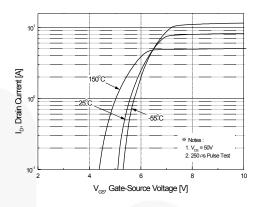


Figure 2. Transfer Characteristics

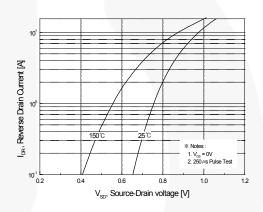


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

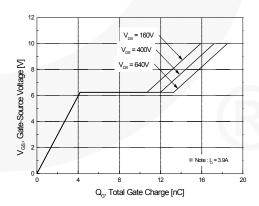


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

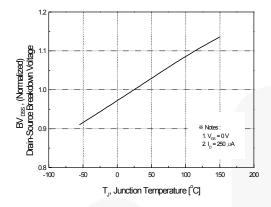


Figure 7. Breakdown Voltage Variation vs. Temperature

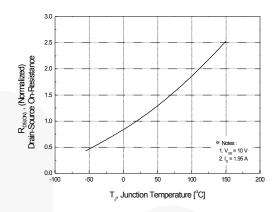


Figure 8. On-Resistance Variation vs. Temperature

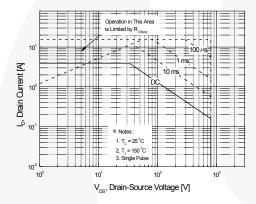


Figure 9. Maximum Safe Operating Area

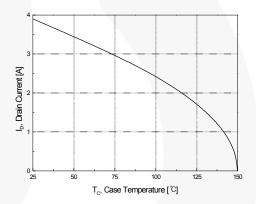


Figure 10. Maximum Drain Current vs. Case Temperature

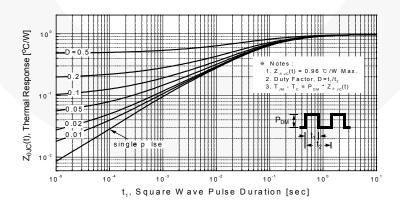


Figure 11. Transient Thermal Response Curve

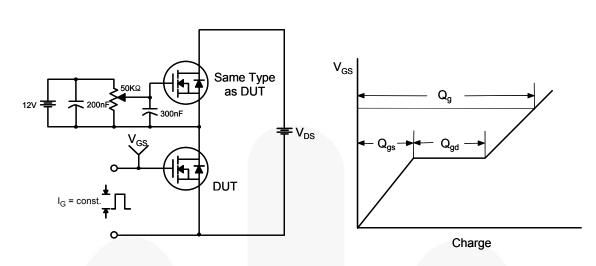


Figure 12. Gate Charge Test Circuit & Waveform

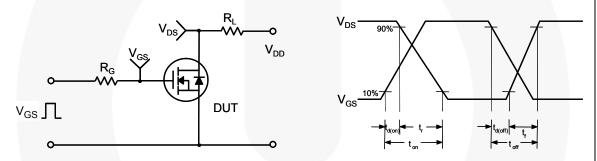


Figure 13. Resistive Switching Test Circuit & Waveforms

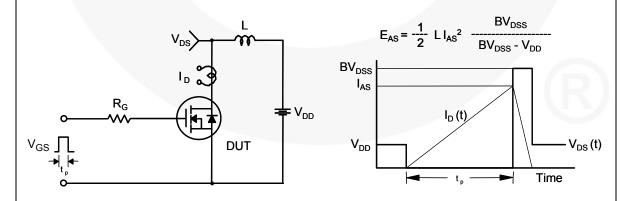


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

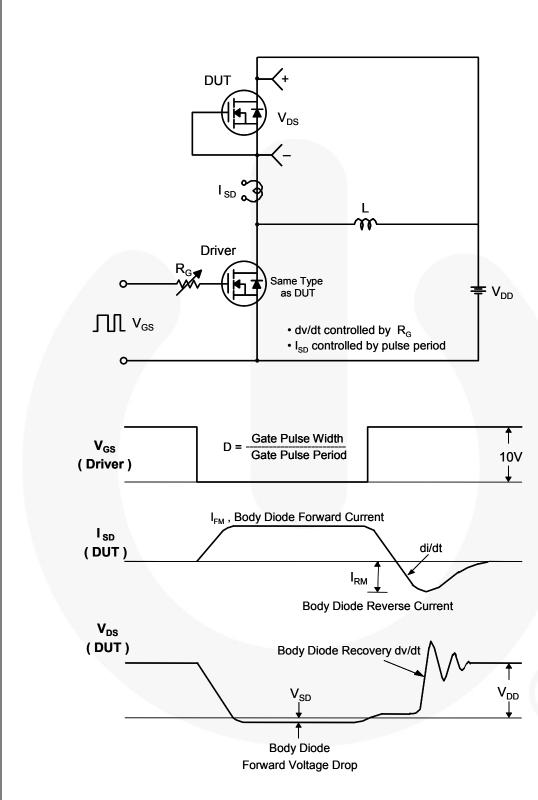


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions

TO-263 2L (D²PAK)

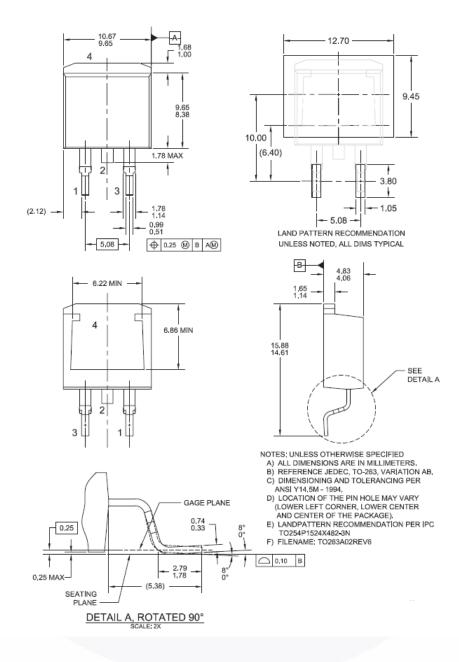


Figure 16. 2LD, TO263, Surface Mount

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Dimension in Millimeters

Mechanical Dimensions

TO-262 3L (I²PAK)

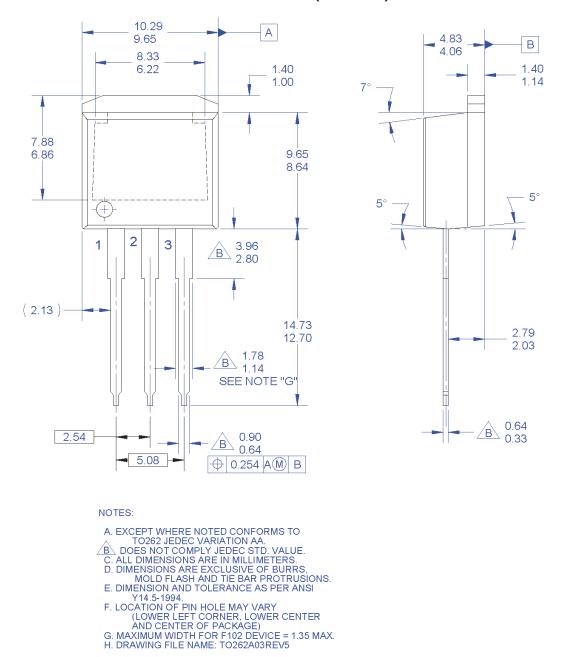


Figure 17. 3LD, TO262, Jedec Variation AA (I²PAK)

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Dimension in Millimeters





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